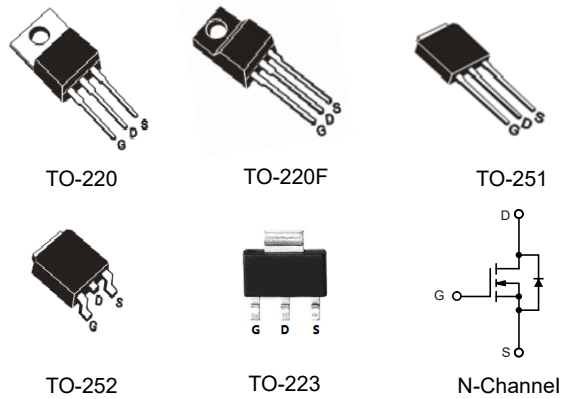


1.Features

- $V_{DS(V)}=650V$
- $I_D=2A$
- $R_{DS(ON)}=4.5\Omega$

2.Pinning information

Pin	Symbol	Description
1	G	GATE
2	D	DRAIN
3	S	SOURCE



3.Absolute Maximum Ratings $T_C = 25^\circ C$

Parameter		Symbol	Rating	Units
Drain-source Voltage		V_{DS}	650	V
gate-source Voltage		V_{GS}	± 30	V
Continuous Drain Current	$T_C=25^\circ C$	I_D	2*	A
Continuous Drain Current	$T_C=100^\circ C$	I_D	1.25*	A
Drain Current – Pulsed ①		I_{DM}	8*	A
Power Dissipation	TO-220	P_{tot}	40	W
	TO-220F		21	W
	TO-251/TO-252		28	W
Junction Temperature		T_J	150	$^\circ C$
Storage Temperature		T_{STG}	-55 to 150	$^\circ C$
Single Pulse Avalanche Energy ②		E_{AS}	120	mJ

*Drain current limited by maximum junction temperature



4.Thermal Resistance Rating

Parameter	Symbol	MAX		Units
		TO-220	TO-220F	
Thermal Resistance Junction-lead	R_{thJL}	2.31	5.43	°C/W
Thermal Resistance Junction-ambient	R_{thJA}	62.5	62.5	°C/W



5. Electrical Characteristic (T_c=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V
Breakdown Voltage Temperature Coefficient	$\frac{\Delta BV_{DSS}}{\Delta T_J}$	I _D =250μA Referenced to 25°C		0.6		V/°C
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2		4	V
Drain-source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V, T _J =25°C			25	μA
		V _{DS} =520V, V _{GS} =0V, T _J =125°C			250	μA
Gate-body Leakage Current (V _{DS} =0)	I _{GSS}	V _{GS} =±30V			±100	nA
Static Drain-source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1A ③		4.5	5.5	Ω
Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, f=1MHz		311		pF
Turn -Off Delay Time	t _{D(off)}	V _{DD} =300V, I _D =2A, R _G =25Ω ③		24		ns
Total Gate Charge	Q _g	I _D =2A, V _{DS} =520V, V _{GS} =10V ③		14.5		nC
Gate-to-Source Charge	Q _{gs}			1.8		nC
Gate-to-Drain Charge	Q _{gd}			8.3		nC
Continuous Diode Forward Current	I _S				2	A
Diode Forward Voltage	V _{SD}	T _J =25°C, I _S =2A, V _{GS} =0V ③			1.4	V
Reverse Recovery Time	t _{rr}	T _J =25°C, I _F =2A		368		ns
Reverse Recovery Charge	Q _{rr}	di/dt=100A/μs ③		1		nC

Notes:

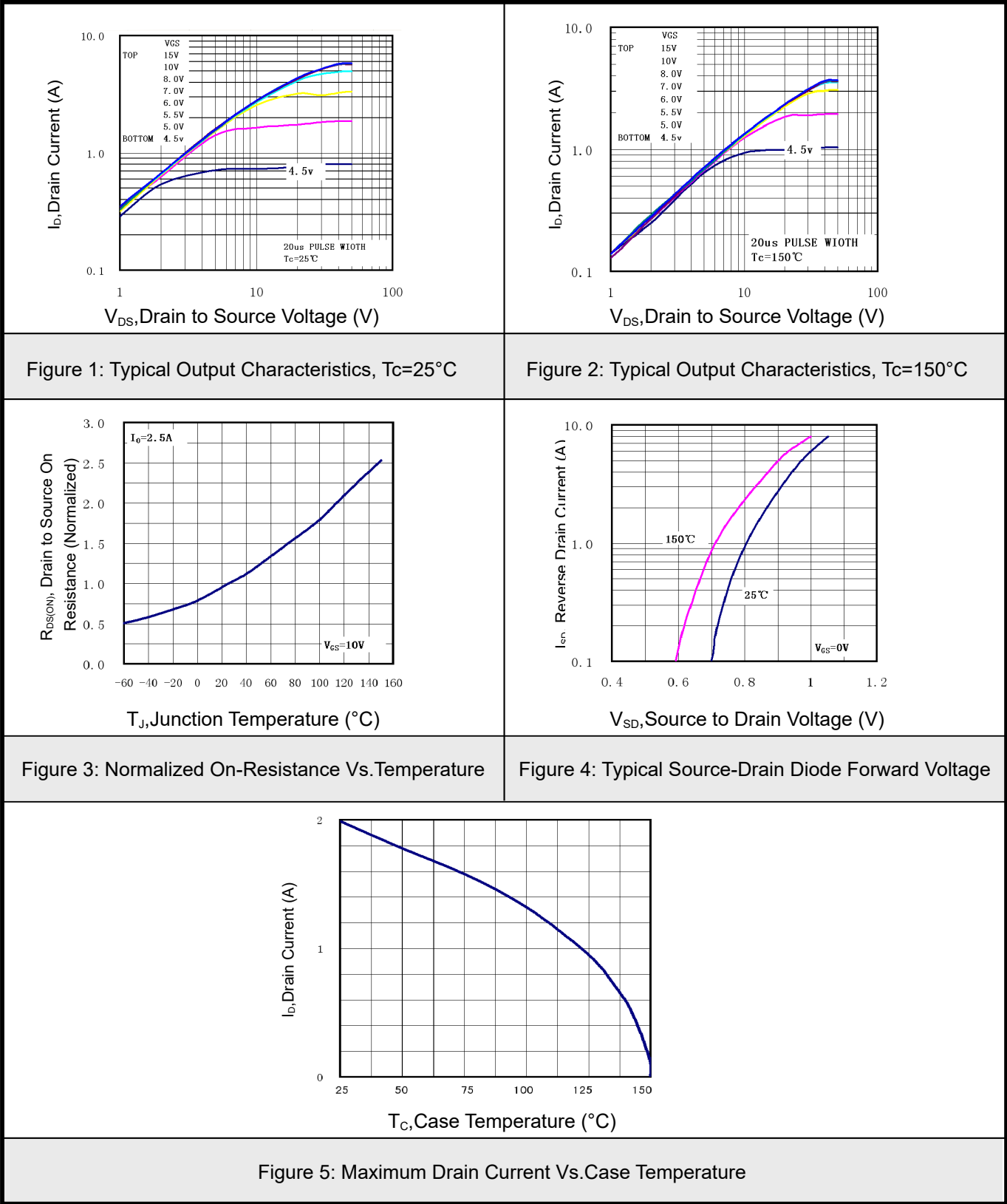
① Repetitive rating: Pulse width limited by maximum junction temperature.

② Starting T_J=25°C, V_{DD} =50V, L=56mH, R_G =25Ω, I_{AS}=2A.

③ Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.

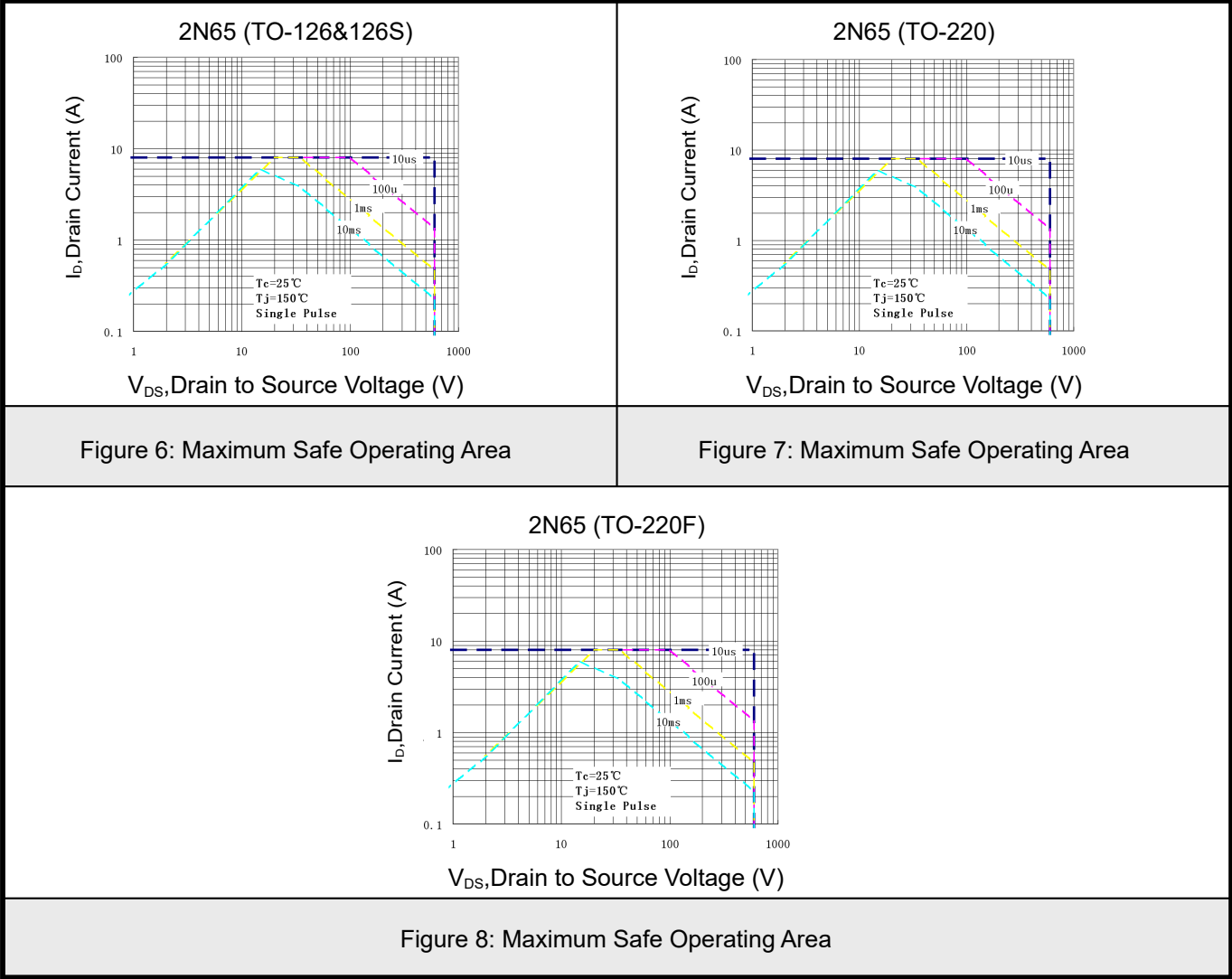


6.1 Typical Characteristic



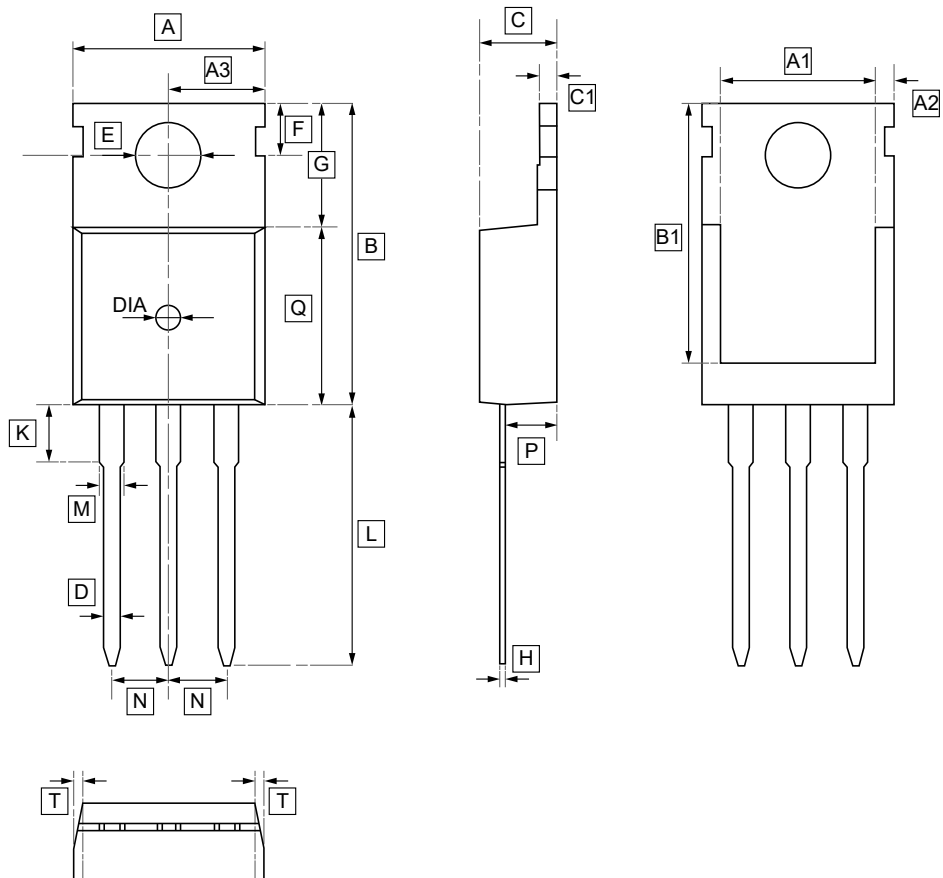


6.2Typical Characteristic





7.1 TO-220 Package Outline Dimensions



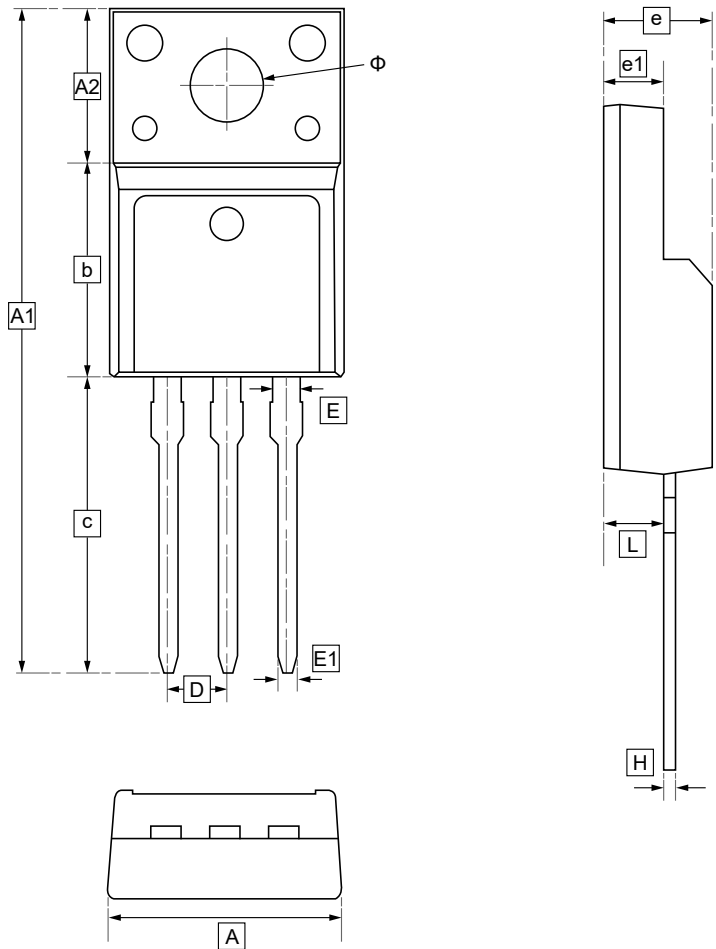
DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	A3	B	B1	C	C1	D	E	F	G
Min	9.7	8.44	1.05	4.8	15.4	12.9	4.28	1.1	0.6	3.4	2.65	5.2
Max	10.3	8.84	1.25	5.2	16.2	13.5	4.68	1.5	1.0	3.8	3.25	5.8

Symbol	H	K	L	L1	M	N	P	Q	T	DIA
Min	0.4	2.9	12.8	2.7	1.15	2.49	2.1	8.7	W:0.35	⌀1.5
Max	0.6	3.3	13.6	3.3	1.35	2.59	2.7	9.3		(deep 0.2)



7.2 TO-220F Package Outline Dimensions



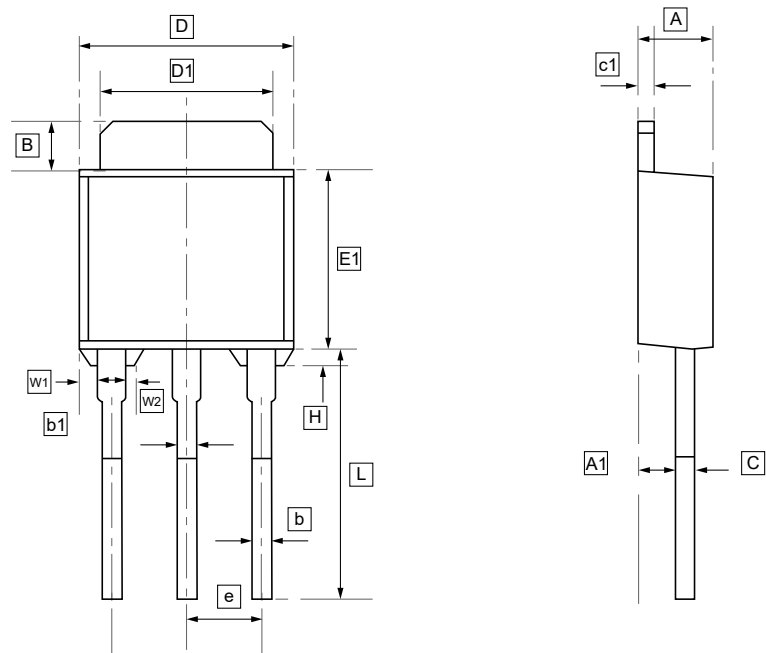
DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	b	c	D	E	E1	Φ	e	e1	L
Min	10.00	28.80	6.58	9.12	12.95	2.54	1.15	0.75	3.13	4.50	2.40	2.50
Max	10.20	29.20	6.78	9.32	13.25		1.25	0.85	3.23	4.70	2.60	2.70

Symbol	H
Min	0.45
Max	0.55



7.3 TO-251T (IPAK) Package Outline Dimensions

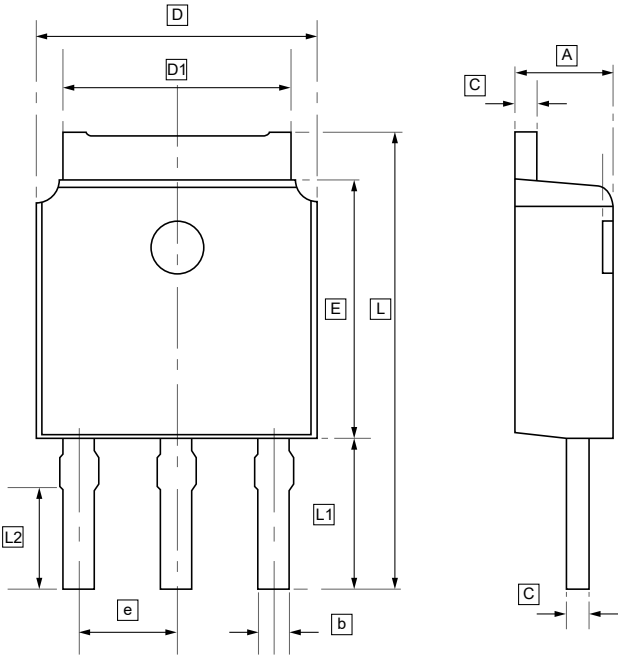


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	B	b	b1	c	c1	D	D1	E	e	L	H	W1	W2
Min	2.10	0.95	0.80	0.50	0.70	0.45	0.45	6.35	5.10	5.30	2.25	7.00	0.35	0.30	0.20
Max	2.50	1.30	1.25	0.80	0.80	0.70	0.70	6.80	5.50	6.30	2.35	9.20	0.45	0.50	0.40



7.4 TO-251S Package Outline Dimensions

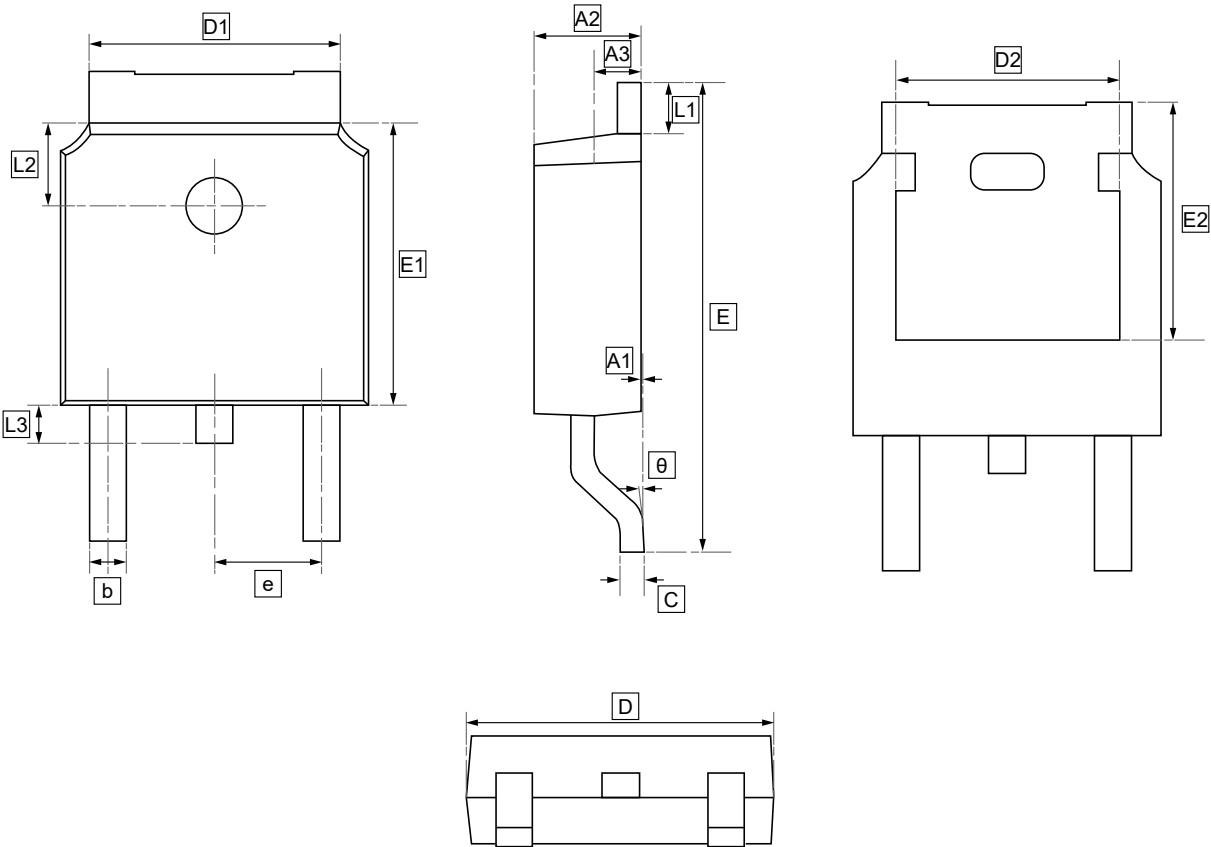


DIMENSIONS (mm are the original dimensions)

Symbol	A	b	C	D	D1	E	e	L	L1	L2
Min	2.20	0.60	0.45	6.50	5.10	5.9	2.18	11.00	4.8	3.5
Max	2.40	0.85	0.60	6.70	5.50	6.20	2.38	12.40	5.3	4.2



7.5 TO-252 Package Outline Dimensions

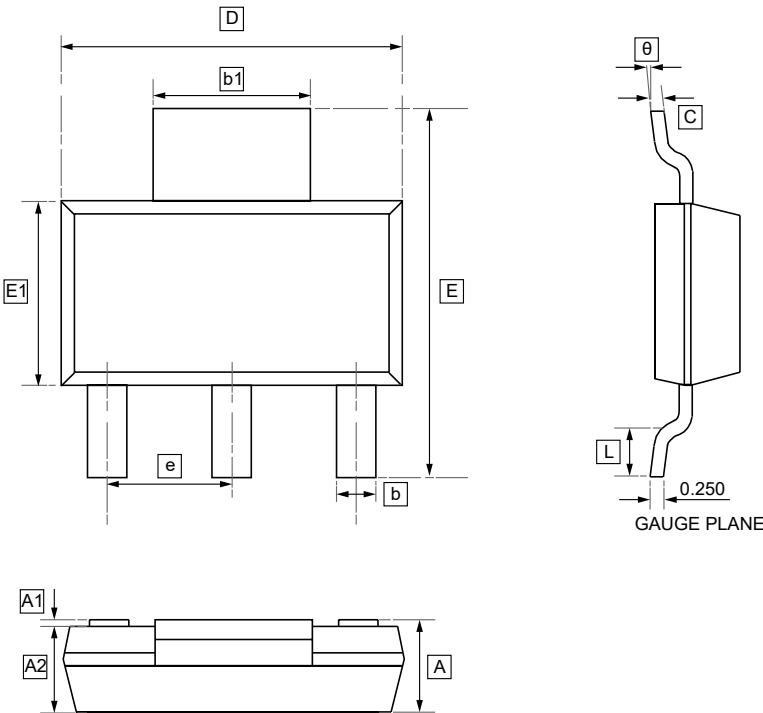


DIMENSIONS (mm are the original dimensions)

Symbol	A1	A2	A3	b	c	D	D1	D2	E	E1	E2	e	L1	L2	L3	θ
Min	0.00	2.18	0.90	0.65	0.46	6.35	4.95	4.32	9.40	5.97	5.21	2.286 BSC	0.89	1.70	0.60	0.00
Max	0.13	2.39	1.10	0.85	0.61	6.73	5.46	4.90	10.41	6.22	5.38		1.27	1.90	1.00	8.00



7.6 SOT-223 Package Outline Dimensions

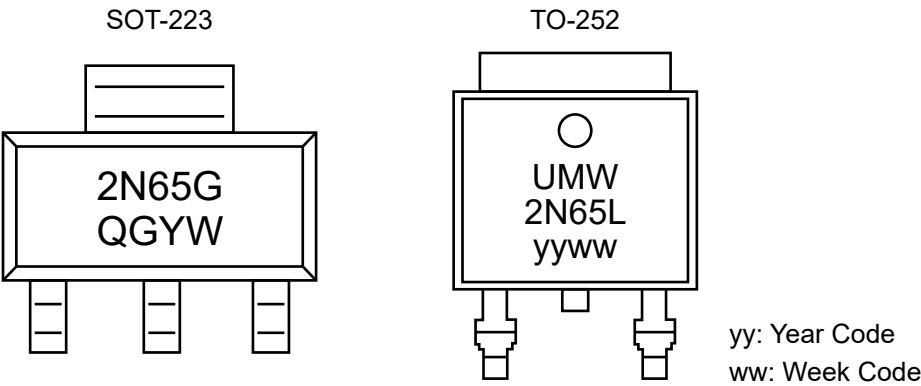


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	b	b1	c	D	E	E1	e	L	θ
Min	-	0.020	1.500	0.660	2.900	0.230	6.300	6.700	3.300	2.300	0.750	0°
Max	1.800	0.100	1.700	0.840	3.100	0.350	6.700	7.300	3.700	BSC	-	10°



8.Ordering Information



Order Code	Marking	Package	Base QTY	Delivery Mode
UMW 2N65G	2N65G	SOT-223	2500	Tape and reel
UMW 2N65L	2N65L	TO-252	2500	Tape and reel



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